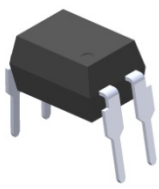
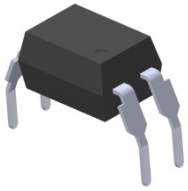
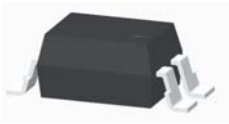
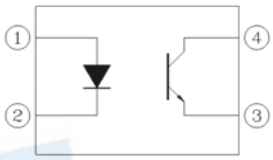
DATASHEET

4 PIN DIP HIGH VOLTAGE PHOTOTRANSISTOR PHOTOCOUPLER
EL851 Series

Schematic



Pin Configuration
1. Anode
2. Cathode
3. Emitter
4. Collector

Features:

- Compliance Halogens Free (Only copper leadframe)
  (Br < 900 ppm, Cl < 900 ppm, Br+Cl < 1500 ppm)
- High collector- emitter voltage (V_{CEO} = 350V)
- Current transfer ratio
  (CTR: 50~600% at I_F = 5mA, V_{CE} = 5V)
- High isolation voltage between input
  and output (Viso = 5000 Vrms)
- Compact dual-in-line package
- The product itself will remain within RoHS compliant version
- Compliance with EU REACH
- Pb free
- UL and cUL approved (No. E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved

Description

The EL851 series devices consist an infrared emitting diodes, optically coupled to a phototransistor detector.
The devices are in a 4-pin DIP package and available in wide-lead spacing and SMD option.

Applications

- Telephone line interface
- Interface to power supply circuit
- Controller for SSRs. DC motor
- Programmable Controllers

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Absolute Maximum Ratings (Ta=25℃)

Parameter		Symbol	Rating	Unit
Input	Forward current	I_F	60	mA
	Peak forward current (1μs pulse)	I_{FM}	1	A
	Reverse voltage	V_R	6	V
	Power dissipation	P_D	100	mW
Output	Collector power dissipation	P_C	150	mW
	Collector-Emitter voltage	V_{CEO}	350	V
	Collector Current	I_C	50	mA
	Emitter-Collector voltage	V_{ECO}	7	V
Total Power Dissipation		P_{TOT}	200	mW
Isolation Voltage*1		V_{ISO}	5000	V rms
Operating Temperature		T_{OPR}	-55 to 100	°C
Storage Temperature		T_{STG}	-55 to 125	°C
Soldering Temperature*2		T_{SOL}	260	°C

Notes:
*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.
*2 For 10 seconds

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Electro-Optical Characteristics (Ta=25℃ unless specified otherwise)

Input

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Forward Voltage	V_F	-	1.2	1.4	V	I_F = 10mA
Reverse Current	I_R	-	-	10	μA	V_R = 5V
Input capacitance	C_{in}	-	30	250	pF	V = 0, f = 1kHz

Note: Reverse Voltage(VR) Condition is applied to IR test only The device is not designed for reverse operation

Output

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
Collector-Emitter dark current	I_{CEO}	-	-	100	nA	V_{CE} = 200V
Collector-Emitter breakdown voltage	BV_{CEO}	350	-	-	V	I_C = 0.1mA
Emitter-Collector breakdown voltage	BV_{ECO}	7	-	-	V	I_E = 0.1mA
Collector-Emitter capacitance	C_{CE}	-	10	-	pF	VCE = 0V, f = 1MHz

Transfer Characteristics

Parameter	Symbol	Min	Typ.	Max.	Unit	Condition
Current Transfer Ratio	CTR	50	-	600	%	I_F = 5mA ,V_{CE} = 5V
Collector-emitter saturation voltage	$V_{CE(sat)}$	-	-	0.4	V	I_F = 20mA , I_C = 1mA
Isolation resistance	R_{IO}	10^{11}	-	-	Ω	V_{IO} = 500Vdc
Input-output capacitance	C_{IO}	-	0.6	-	pF	V_{IO} = 0, f = 1MHz
Rise time	t_r	-	4	18	μs	V_{CE} = 2V, I_C = 2mA, R_L = 100Ω
Fall time	t_f	-	5	18	μs	

* Typical values at T_a = 25°C

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Typical Electro-Optical Characteristics Curves

Figure 1. Forward Current vs Forward Voltage

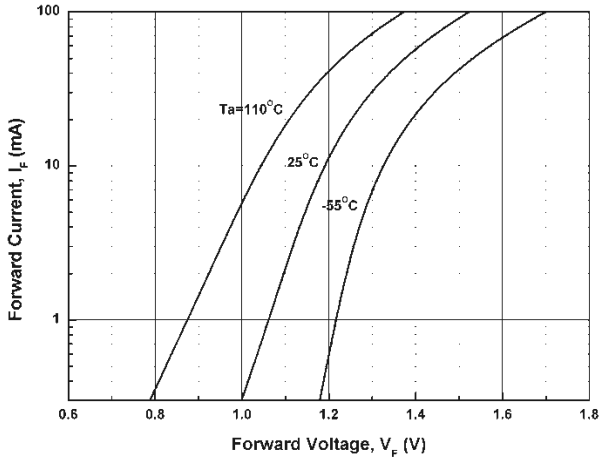


Figure 2. Current Transfer Ratio vs Forward Current

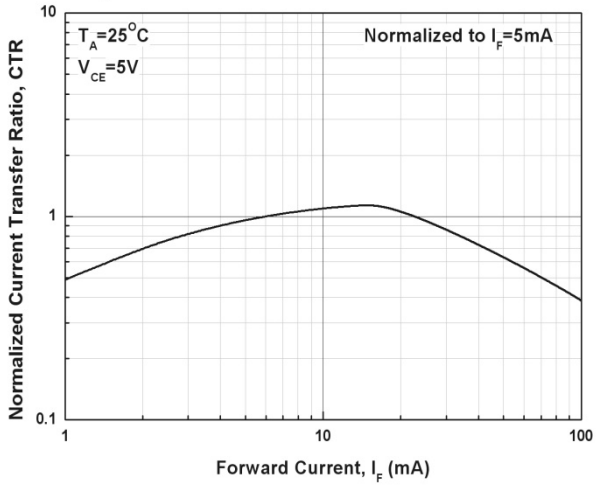


Figure 3. Collector Current vs Collector-emitter Voltage

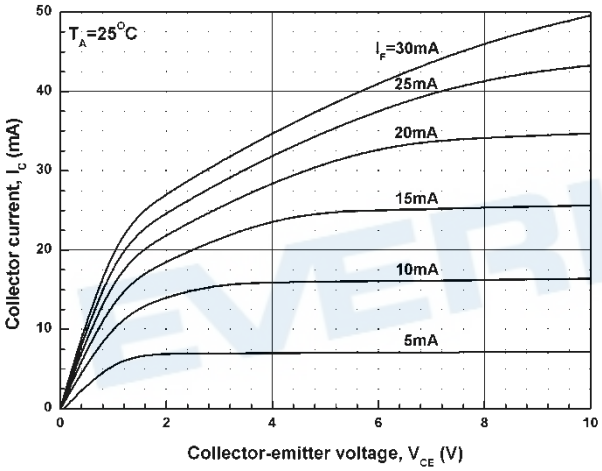


Figure 4. Relative Current Transfer Ratio vs Ambient Temperature

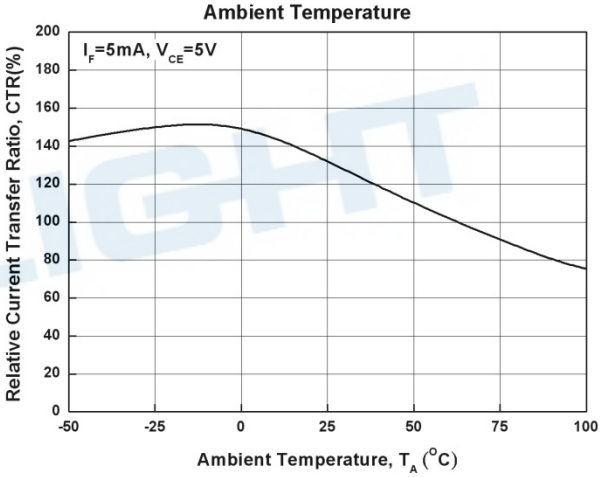


Figure 5. Collector-emitter Saturation Voltage vs Ambient Temperature

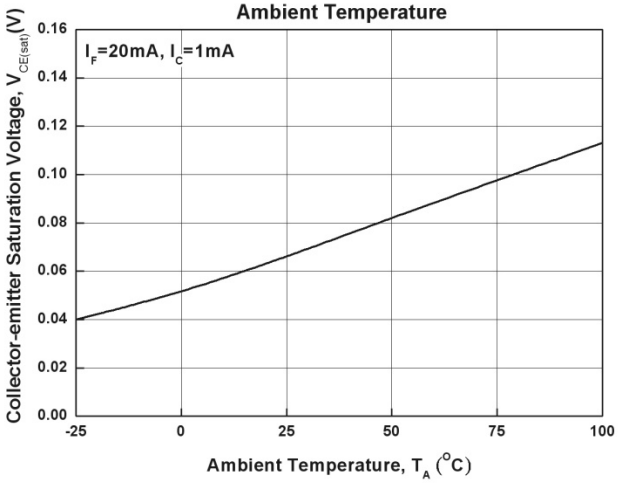
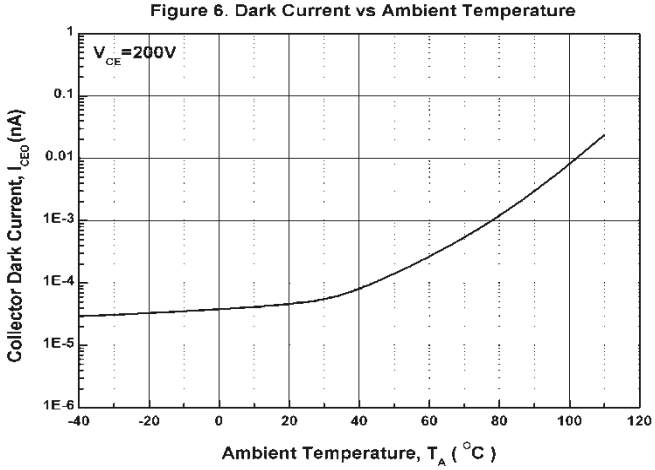


Figure 6. Dark Current vs Ambient Temperature



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Figure .7 Switching Time vs. Load Resistance

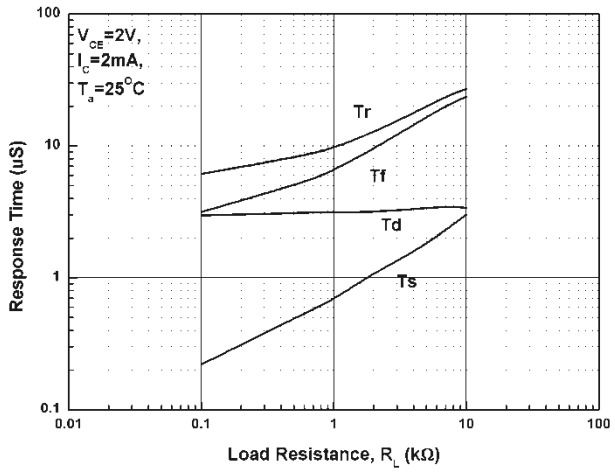
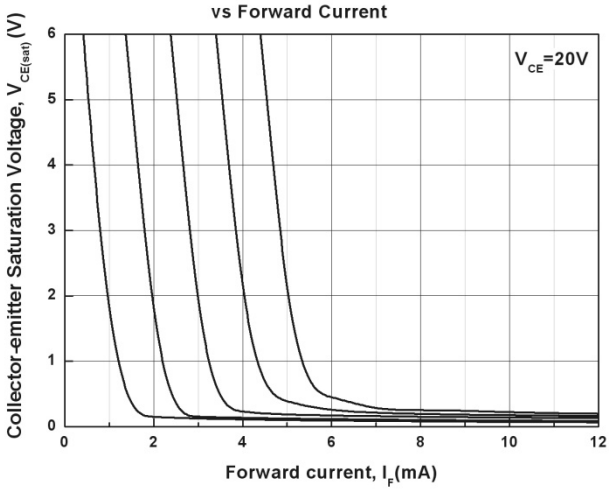


Figure 8. Collector-emitter Saturation Voltage vs Forward Current



Note：The graphs shown in this datasheet are representing typical data only and do not show guaranteed values

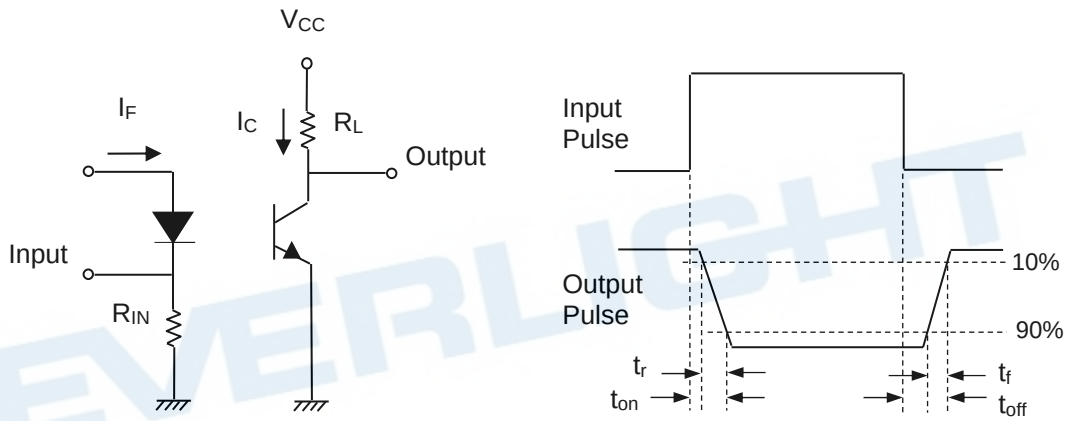


Figure 9. Switching Time Test Circuit & Waveforms

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Order Information

Part Number

EL851X(Z)-V

Note

X = Lead form option (S1, M or none)
Z = Tape and reel option (TA, TB, TU, TD or none)
V = VDE safety (optional)

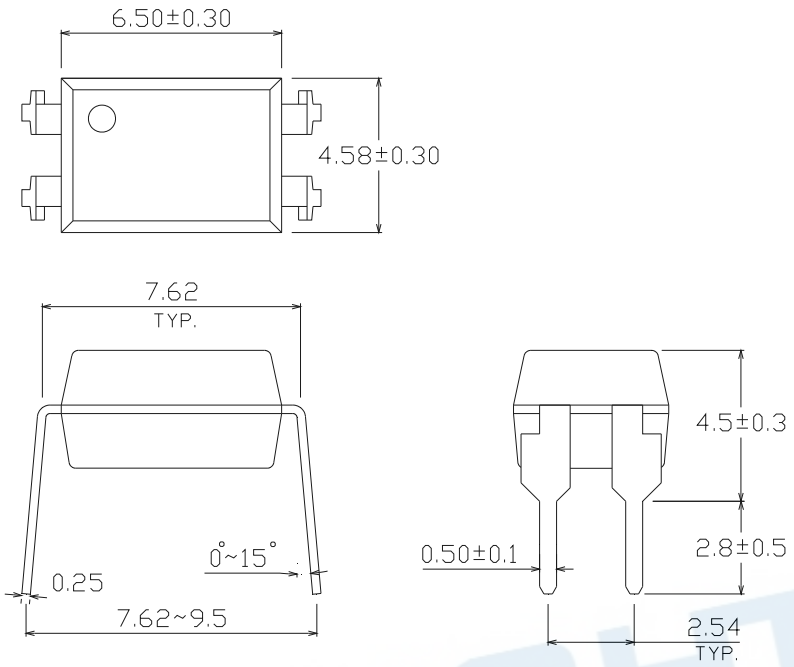
Option	Description	Packing quantity
None	Standard DIP-4	100 units per tube
M	Wide lead bend (0.4 inch spacing)	100 units per tube
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel
S1 (TU)	Surface mount lead form (low profile) + TU tape & reel option	2000 units per reel
S1 (TD)	Surface mount lead form (low profile) + TD tape & reel option	2000 units per reel

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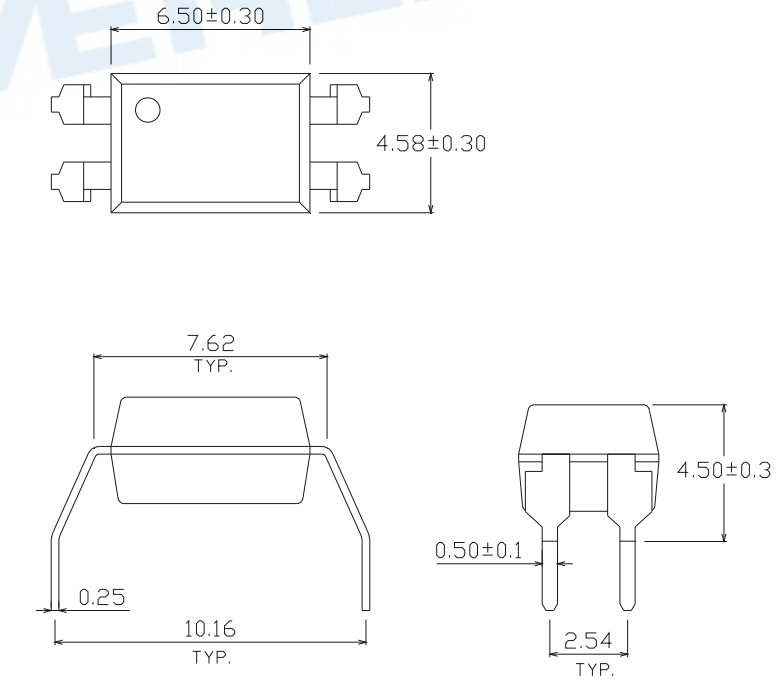
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Package Dimension (Dimensions in mm)

Standard DIP Type



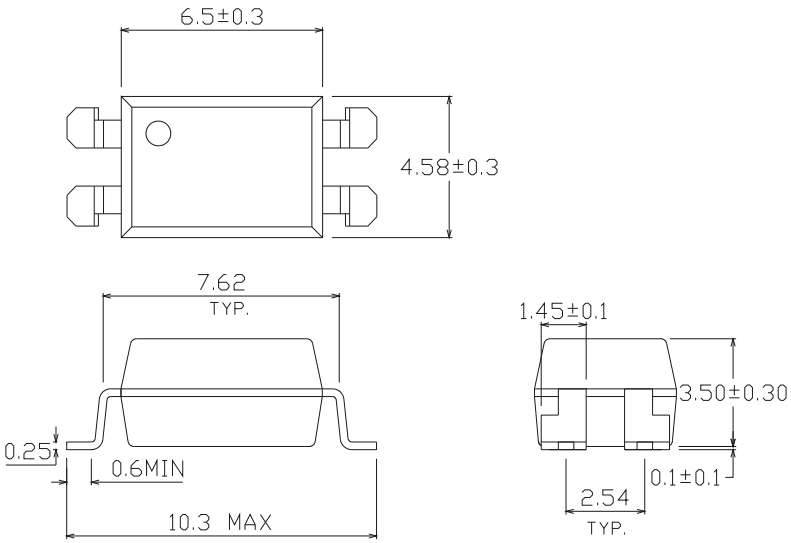
Option M Type



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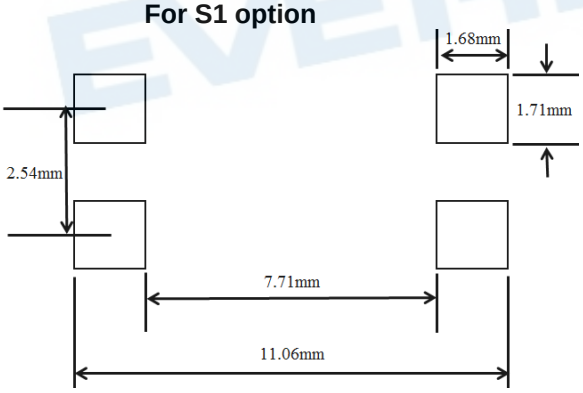
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Option S1 Type



Recommended pad layout for surface mount leadform

For S1 option



Notes

Suggested pad dimension is just for reference only.
Please modify the pad dimension based on individual need.

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Device Marking



Notes

EL	denotes EVERLIGHT
851	denotes Device Number
Y	denotes 1 digit Year code
WW	denotes 2 digit Week code
V	denotes VDE (optional)

EVERLIGHT

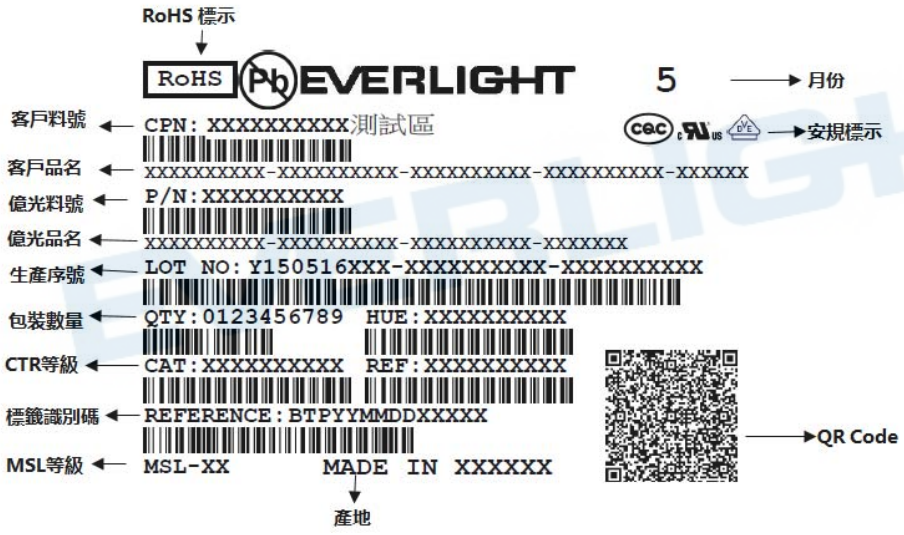
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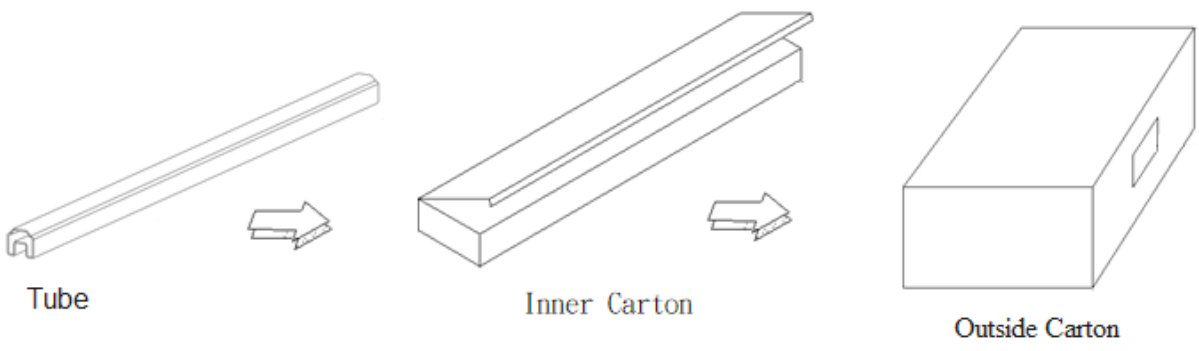
Label form



or



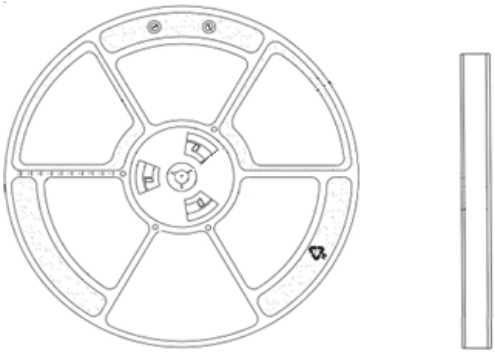
TUBE Dimension



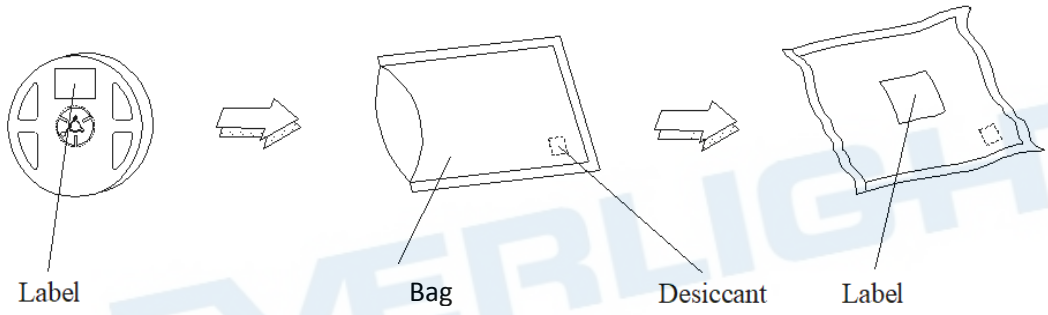
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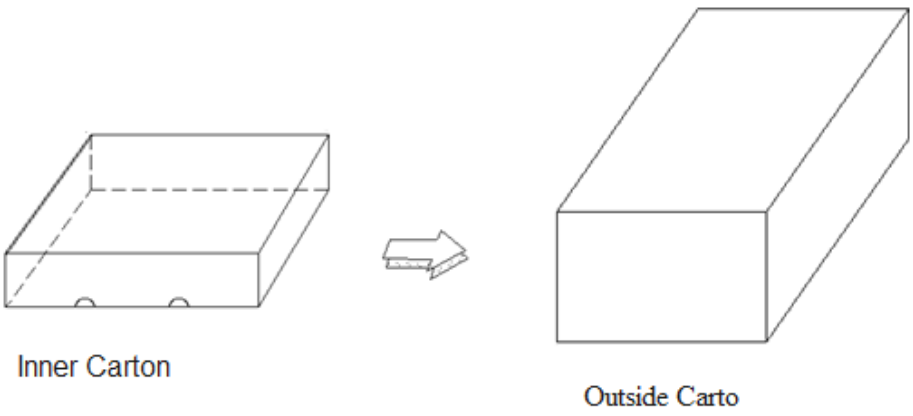
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Reel Dimension



Moisture Resistant Packaging



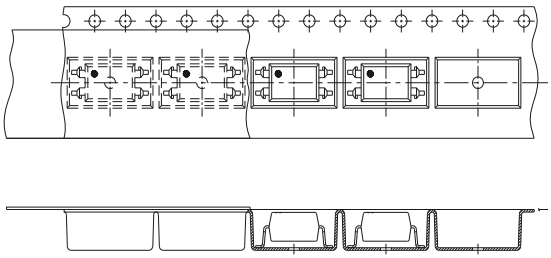


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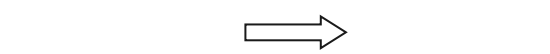
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Tape & Reel Packing Specifications

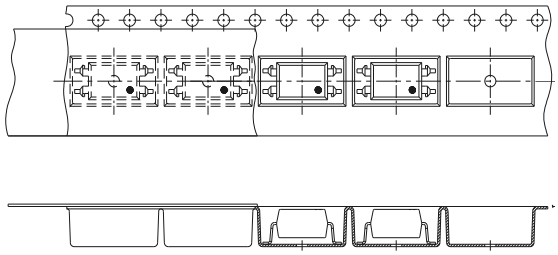
Option TA



Direction of feed from reel



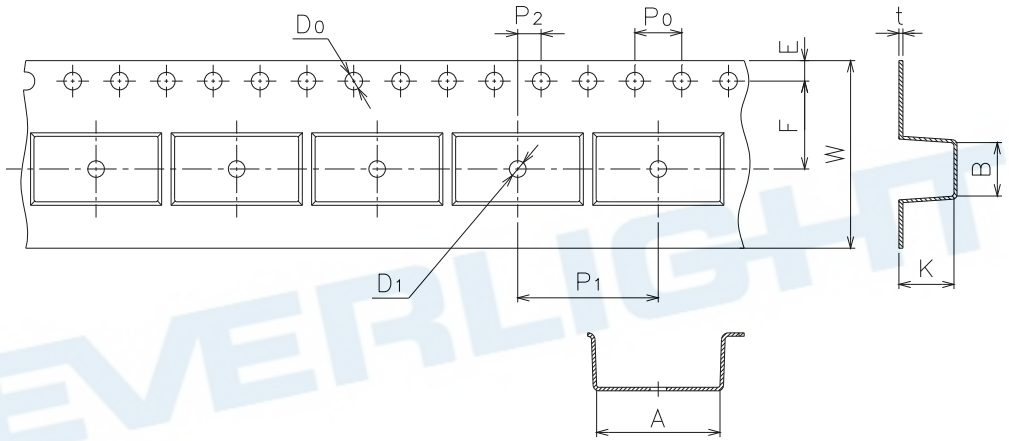
Option TB



Direction of feed from reel



Tape dimensions

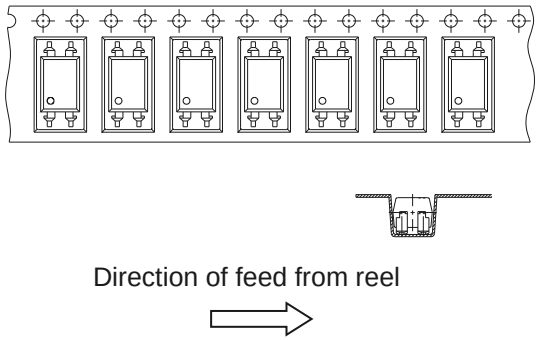


Dimension No.	A	B	Do	D1	E	F
Dimension (mm) S1	10.7±0.1	4.65±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.5±0.1
Dimension No.	**Po**	**P1**	**P2**	**t**	**W**	**K**
Dimension (mm) S1	4.0±0.1	12.0±0.1	2.0±0.1	0.4±0.1	16.0±0.3	3.90±0.1

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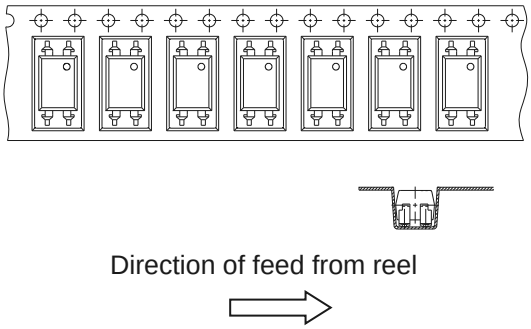
Tape & Reel Packing Specifications

Option TD



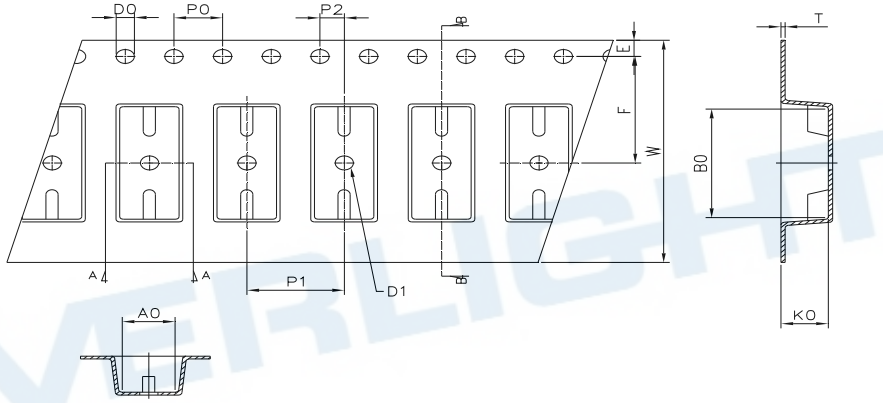
Direction of feed from reel

Option TU



Direction of feed from reel

Tape dimensions



Dimension No.	**Ao**	**Bo**	**Do**	**D1**	**E**	**F**
Dimension (mm)	4.90±0.1	10.40±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.50±0.1
Dimension No.	**Po**	**P1**	**P2**	**t**	**W**	**Ko**
Dimension(mm)	4.00±0.1	8.00±0.1	2.00±0.1	0.40±0.1	16.00±0.3	4.00±0.1

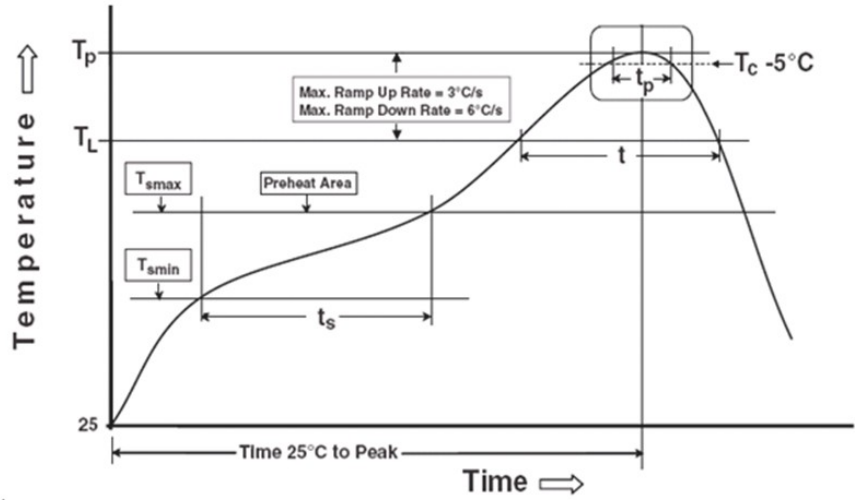
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Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note: Reference: IPC/JEDEC J-STD-020D

Preheat	
Temperature min (T_{smin})	150 °C
Temperature max (T_{smax})	200°C
Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds
Average ramp-up rate (T_{smax} to T_p)	3 °C/second max
Other	
Liquidus Temperature (T_L)	217 °C
Time above Liquidus Temperature (t_L)	60-100 sec
Peak Temperature (T_P)	260°C
Time within 5 °C of Actual Peak Temperature: T_P - 5°C	30 s
Ramp- Down Rate from Peak Temperature	6°C /second max.
Time 25°C to peak temperature	8 minutes max.
Reflow times	3 times

.

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Precautions for General Storage

- Avoid storage locations where devices may be exposed to moisture or direct sunlight.
- Follow the precautions printed on the packing label of the device for transportation and storage.
- Keep the storage location temperature and humidity within a range of 5°C to 35°C and 20 % to 60 %,respectively.
- Do not store the products in locations with poisonous gases (especially corrosive gases) or in dusty conditions.
- Store the products in locations with minimal temperature fluctuations. Rapid temperature changes during storage can cause condensation, resulting in lead oxidation or corrosion, which will deteriorate the solderability of the leads.
- When restoring devices after removal from their packing, use anti-static containers.
- Do not allow loads to be applied directly to devices while they are in storage.
- If devices have been stored for more than two years under normal storage conditions, it is recommended that you check the leads for ease of soldering prior to use.

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1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
2. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
3. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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